Designer's™ Data Sheet

Switchmode Series Ultra-Fast NPN Silicon Power Transistors

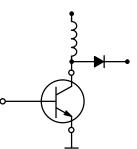
These transistors are designed for high–voltage, high–speed, power switching in inductive circuits where fall time is critical. They are particularly suited for line–operated switchmode applications.

- Switching Regulators
- Inverters
- Motor Controls
- · Deflection Circuits
- Fast Turn-Off Times
 30 ns Inductive Fall Time 75°C (Typ)
 50 ns Inductive Crossover Time 75°C (Typ)

600 ns Inductive Storage Time — 75°C (Typ)

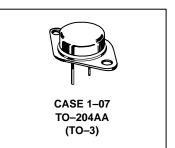
- Operating Temperature Range -65 to +200°C
- 100°C Performance Specified for:

Reverse–Biased SOA with Inductive Loads Switching Times with Inductive Loads Saturation Voltages Leakage Currents



2N6836

15 AMPERE
NPN SILICON
POWER TRANSISTOR
450 VOLTS
175 WATTS



MAXIMUM RATINGS (2)

Rating	Symbol	Max	Unit
Collector–Emitter Voltage	VCEO(sus)	450	Vdc
Collector–Emitter Voltage	VCEV	850	Vdc
Emitter Base Voltage	V _{EB}	6.0	Vdc
Collector Current — Continuous — Peak (1)	IC ICM	15 20	Adc
Base Current — Continuous — Peak (1)	I _B	10 15	Adc
Total Power Dissipation @ T _C = 25°C @ T _C = 100°C Derate above 25°C	PD	175 100 1.0	Watts W/°C
Operating and Storage Junction Temperature Range	T _J , T _{Stg}	-65 to +200	°C

THERMAL CHARACTERISTICS (2)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R ₀ JC	1.0	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5.0 Seconds	TL	275	°C

- (1) Pulse Test: Pulse Width = 5.0 ms, Duty Cycle ≤ 10%.
- (2) Indicate JEDEC Registered Data.

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Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.



ELECTRICAL CHARACTERISTICS (T $_C$ = 25°C unless otherwise noted)

	Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTI	CS (1)						
Collector–Emitter Sus (I _C = 100 mA, I _B =	staining Voltage (Table 2) 0)		VCEO(sus)	450*	_	_	Vdc
Collector Cutoff Current (VCEV = 850 Vdc, VBE(off) = 1.5 Vdc) (VCEV = 850 Vdc, VBE(off) = 1.5 Vdc, T _C = 100°C)		ICEV	_		0.25* 1.5*	mAdc	
Collector Cutoff Curre (V _{CE} = 850 Vdc, R	ent BE = 50 Ω, T _C = 100°C)		ICER	_	_	2.5	mAdc
Emitter Cutoff Current (V _{EB} = 6.0 Vdc, I _C			I _{EBO}	_	_	1.0*	mAdc
SECOND BREAKDOW	/N		•				
Second Breakdown C	Collector Current with Base F	orward Biased	I _{S/b}	See Figure 15*			
Clamped Inductive SC	OA with Base Reverse Biase	ed	RBSOA	See Figure 16			
ON CHARACTERISTIC	CS (1)		•				
Collector-Emitter Sat (I _C = 5.0 Adc, I _B = 1 (I _C = 10 Adc, I _B = 1	0.7 Adc)		VCE(sat)	_ _ _	_ _ _	1.2 2.5* 3.0*	Vdc
Base–Emitter Saturat (I _C = 10 Adc, I _B = 1 (I _C = 10 Adc, I _B = 1			VBE(sat)	_		1.5* 1.5	Vdc
DC Current Gain (I _C = 10 Adc, V _{CE} = 5.0 Vdc) (I _C = 15 Adc, V _{CE} = 5.0 Vdc)		hFE	8.0* 5.0	_	30* —	_	
DYNAMIC CHARACTE	ERISTICS (2)					•	
Current Gain — Band (V _{CE} = 10 Vdc, I _C	lwidth Product = 0.25 Adc, f _{test} = 10 MHz)		fT	10*	_	75*	MHz
Output Capacitance ($V_{CB} = 10 \text{ Vdc}$, $I_E = 0$, $f_{test} = 1.0 \text{ kHz}$)		C _{ob}	50*	_	400*	pF	
SWITCHING CHARAC	TERISTICS						
Resistive Load (Tabl	le 1)						
Delay Time			t _d	_	20	100*	ns
Rise Time	(I _C = 10 Adc,	$(I_{B2} = 2.6 \text{ Adc},$	t _r	_	200	500*	
Storage Time	V _{CC} = 250 Vdc, I _{B1} = 1.0 Adc,	$R_{B2} = 1.6 \Omega$	t _S	_	1200	3000*	
Fall Time	$PW = 30 \mu s$,		t _f	_	200	250*]
Storage Time	Duty Cycle ≤ 2.0%)	(\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	t _S	_	650	_]
Fall Time]	$(V_{BE(off)} = 5.0 \text{ Vdc})$	t _f	_	80	_	1
Inductive Load (Tabl	le 2)					-	
Storage Time	(I _C = 10 Adc, I _{B1} = 1.0 Adc,		t _{SV}	_	800	1500*	ns
Fall Time		(T _C = 100°C)	t _{fi}	_	50	150*]
Crossover Time			t _C	_	90	200*	1
Storage Time	$V_{BE(off)} = 5.0 \text{ Vdc},$		t _{SV}	_	1050	_]
Fall Time	V _{CE} (pk) = 400 Vdc)	(T _C = 150°C)	t _{fi}	_	70	_	
Crossover Time]			_	120	_	

⁽¹⁾ Pulse Test: PW \pm 300 μ s, Duty Cycle \leq 2%. (2) fT = |she| f_{test}. * Indicates JEDEC Registered Limit.

TYPICAL STATIC CHARACTERISTICS

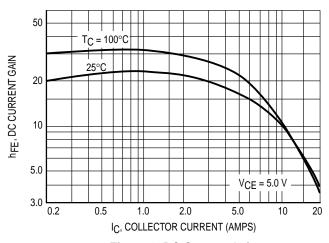


Figure 1. DC Current Gain

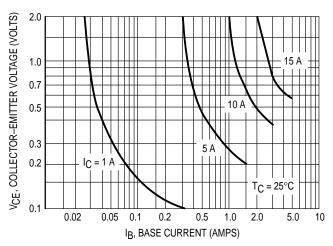


Figure 2. Collector Saturation Region

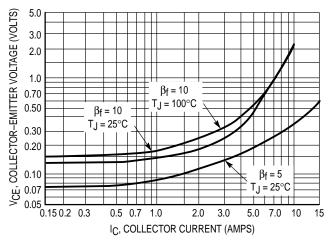


Figure 3. Collector-Emitter Saturation Voltage

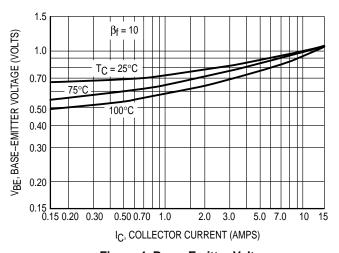


Figure 4. Base–Emitter Voltage

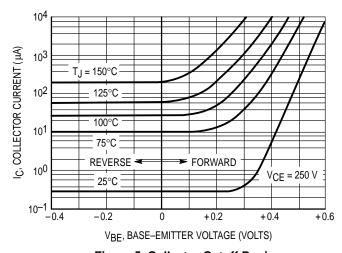


Figure 5. Collector Cutoff Region

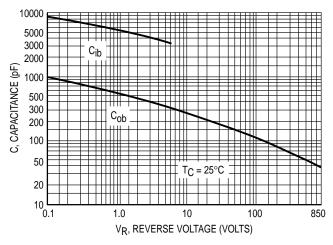


Figure 6. Capacitance

TYPICAL DYNAMIC CHARACTERISTICS

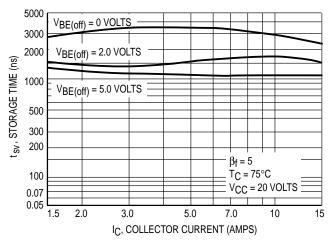


Figure 7. Storage Time

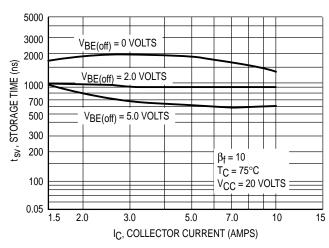


Figure 8. Storage Time

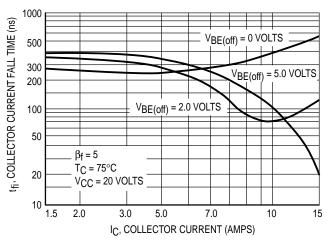


Figure 9. Collector Current Fall Time

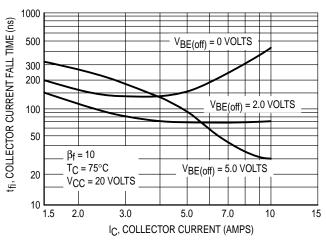


Figure 10. Collector Current Fall Time

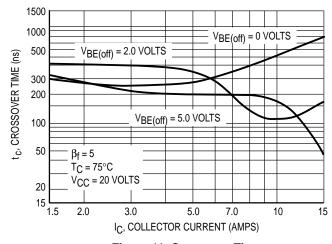


Figure 11. Crossover Time

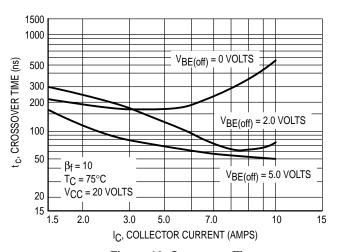


Figure 12. Crossover Time

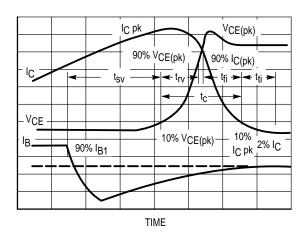


Figure 13. Inductive Switching Measurements

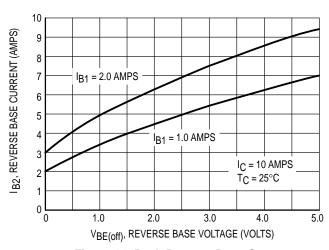


Figure 14. Peak Reverse Base Current

GUARANTEED SAFE OPERATING AREA LIMITS

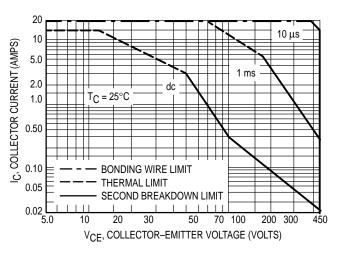


Figure 15. Maximum Forward Bias Safe Operating Area

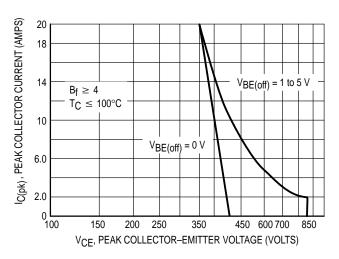


Figure 16. Maximum Reverse Bias Safe Operating Area

SAFE OPERATING AREA INFORMATION

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_{\text{C}} - V_{\text{CE}}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 15 is based on $T_C = 25^{\circ}C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \geq 25^{\circ}C$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 15 may be found at any case temperature by using the appropriate curve on Figure 18.

T_{J(pk)} may be calculated from the data in Figure 17. At high case temperatures, thermal limitations will reduce the power

that can be handled to values less than the limitations imposed by second breakdown.

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn—off, in most cases, with the base—to—emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage—current condition allowable during reverse biased turn—off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 16 gives the RBSOA characteristics.

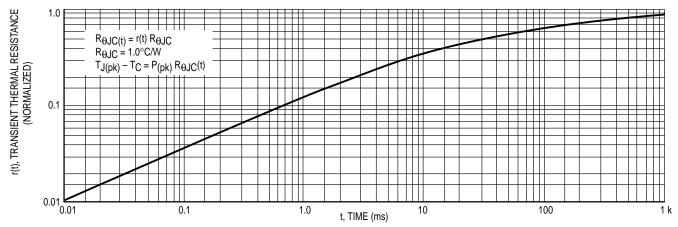


Figure 17. Thermal Response

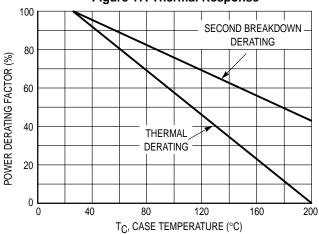
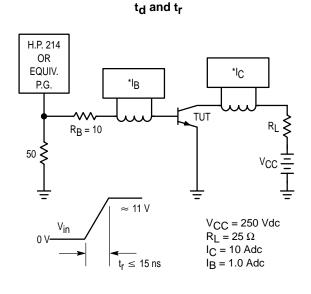
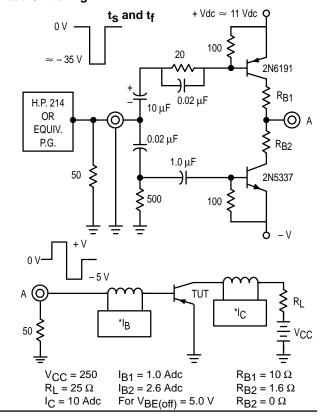


Figure 18. Power Derating

Table 1. Resistive Load Switching

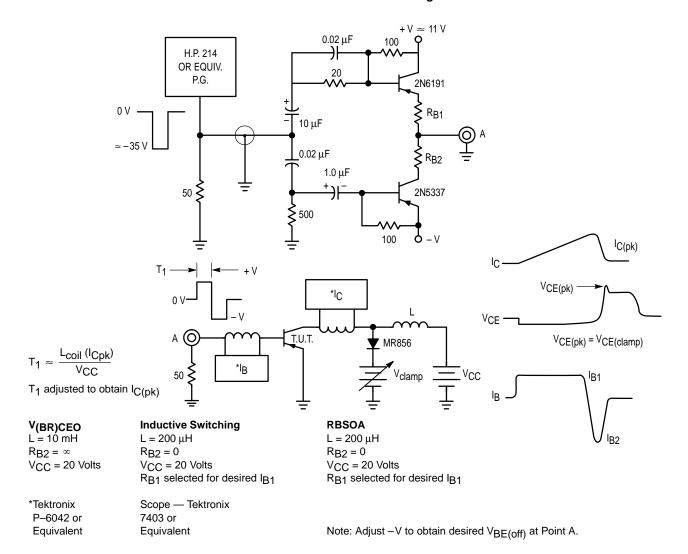


*Tektronix P–6042 or equivalent.



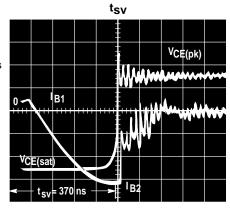
*NOTE: Adjust – V to obtain desired VBE(off) at Point A.

Table 2. Inductive Load Switching

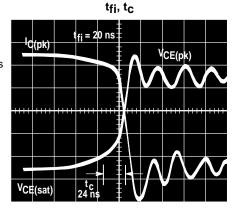


TYPICAL INDUCTIVE SWITCHING WAVEFORMS

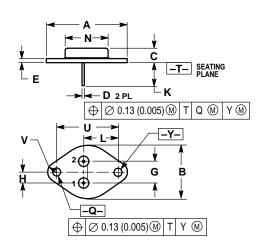
$$\begin{split} &\text{IC(pk)} = 10 \text{ Amps} \\ &\text{IB1} = 1.0 \text{ Amp} \\ &\text{VBE(off)} = 5.0 \text{ Volts} \\ &\text{VCE(pk)} = 400 \text{ Volts} \\ &\text{T}_{\text{C}} = 25^{\circ}\text{C} \\ &\text{Time Base} = \\ &100 \text{ ns/cm} \end{split}$$



 $I_{C(pk)} = 10 \text{ Amps}$ $I_{B1} = 1.0 \text{ Amp}$ $V_{BE(off)} = 5.0 \text{ Volts}$ $V_{CE(pk)} = 400 \text{ Volts}$ $T_{C} = 25^{\circ}\text{C}$ Time Base = 20 ns/cm



PACKAGE DIMENSIONS



NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
 VALUE MARKET AND TOLERANCING PER AND TOLERANCING PE
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
- ALL RULES AND NOTES ASSOCIATED WITH
 REFERENCED TO-204AA OUTLINE SHALL APPLY.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	1.550 REF		39.37	REF	
В	-	1.050		26.67	
C	0.250	0.335	6.35	8.51	
D	0.038	0.043	0.97	1.09	
Е	0.055	0.070	1.40	1.77	
G	0.430 BSC		10.92 BSC		
Н	0.215 BSC		5.46 BSC		
K	0.440	0.480	11.18	12.19	
L	0.665	BSC	16.89 BSC		
N		0.830		21.08	
ø	0.151	0.165	3.84	4.19	
U	1.187 BSC		30.15 BSC		
V	0.131	0.188	3.33	4 77	

STYLE 1:
PIN 1. BASE
2. EMITTER
CASE: COLLECTOR

CASE 1-07 TO-204AA (TO-3) ISSUE Z

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